November 1998

FDS6575 Single P-Channel, Logic Level, PowerTrench™ MOSFET

General Description

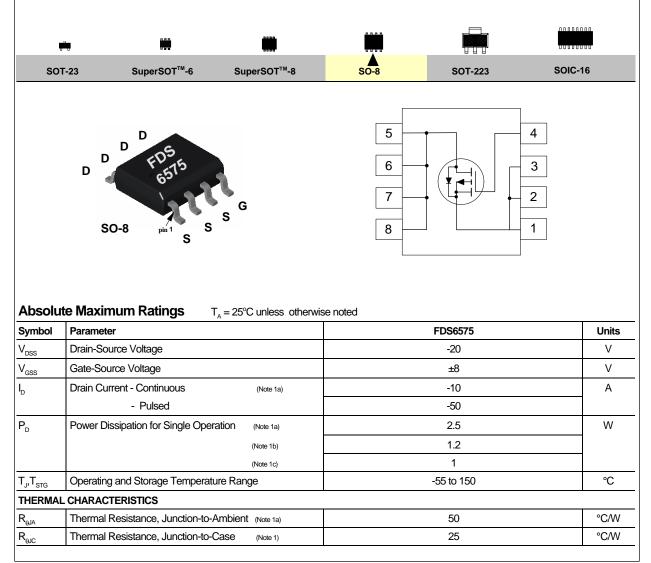
FAIRCHILD

This P-Channel Logic Level MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

These devices are well suited for notebook computer applications: load switching and power management, battery charging circuits, and DC/DC conversion.

Features

- $\label{eq:linear_state} \begin{array}{c} \bullet & -10 \text{ A}, \ -20 \ \text{V}, \ \text{R}_{\text{DS}(\text{ON})} = 0.013 \ \Omega \ @ \ \text{V}_{\text{GS}} = -4.5 \ \text{V}, \\ \text{R}_{\text{DS}(\text{ON})} = 0.017 \ \Omega \ @ \ \text{V}_{\text{GS}} = -2.5 \ \text{V}. \end{array}$
- Low gate charge (50nC typical).
- High performance trench technology for extremely low $R_{\text{DS(ON)}}$
- High power and current handling capability.

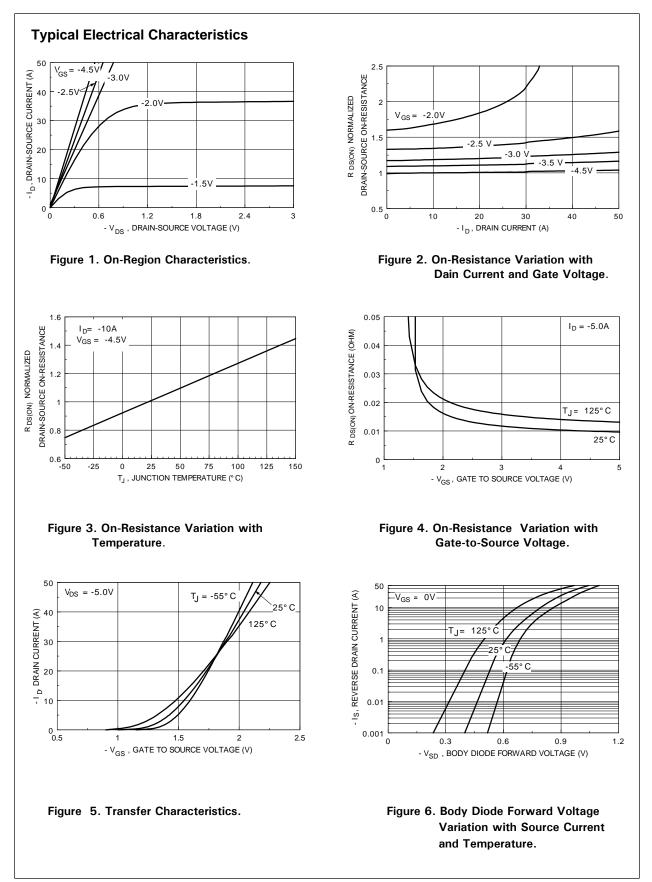


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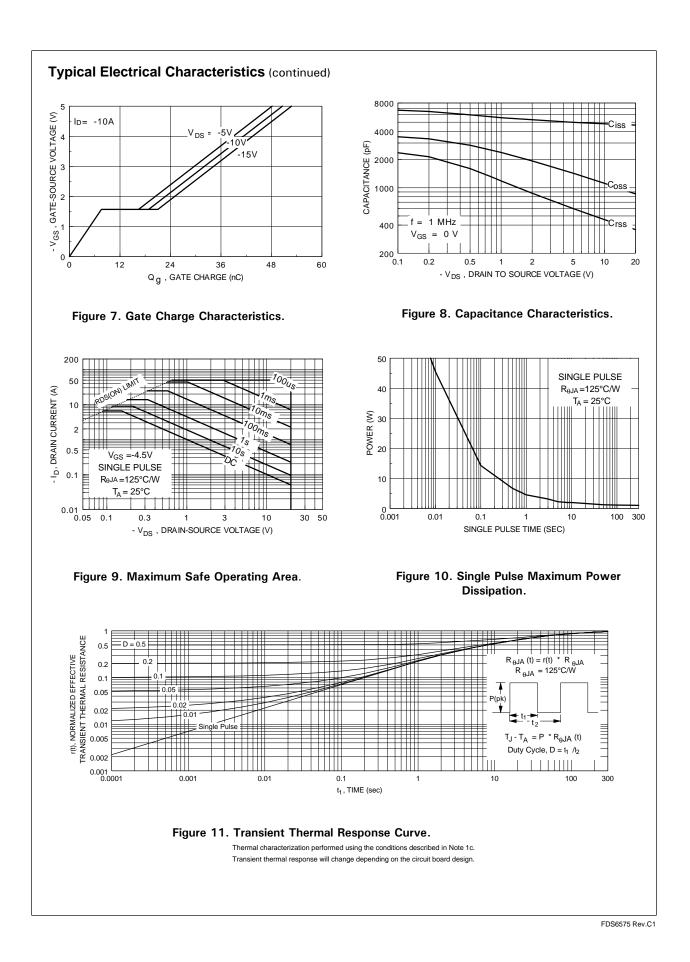
OFF CHAR	Parameter	Conditions		Min	Тур	Max	Units
	ACTERISTICS						
3V _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$		-20			V
ΔBV _{DSS} /ΔT _J	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = -250 µA, Referenced to 25 °C			-19		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$				-1	μA
	_		T_ = 55°C			-10	μA
GSSF	Gate - Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$	-			100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{GS} = -8 V, V_{DS} = 0 V$				-100	nA
	CTERISTICS (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = -250 \ \mu {\rm A}$		-0.4	-0.8	-1.5	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to	o 25 ℃		3		mV/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$			0.01	0.013	Ω
			T_ =125°C		0.015	0.02	
		$V_{GS} = -2.5 \text{ V}, I_{D} = -9 \text{ A}$			0.013	0.017	
D(ON)	On-State Drain Current	$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$		-50			Α
9 _{FS}	Forward Transconductance	V _{DS} = -4.5 V, I _D = -11 A			45		S
DYNAMIC C	HARACTERISTICS						1
C _{iss}	Input Capacitance	$V_{DS} = -15 V, V_{GS} = 0 V,$			4800		pF
C _{oss}	Output Capacitance	f = 1.0 MHz	f = 1.0 MHz		1100		pF
C _{rss}	Reverse Transfer Capacitance				460		pF
SWITCHING	CHARACTERISTICS (Note 2)			-	-		
D(on)	Tum - On Delay Time	V_{DS} = -10 V, I_{D} = -1 A			30	50	ns
т	Turn - On Rise Time	$V_{\rm GEN}$ = -4.5 V, $\rm R_{\rm GEN}$ = 6 Ω	V_{GEN} = -4.5 V, R_{GEN} = 6 Ω		20	35	ns
D(off)	Turn - Off Delay Time				175	250	ns
f	Turn - Off Fall Time				80	110	ns
Q	Total Gate Charge	$V_{DS} = -15 V, I_{D} = -10 A,$			50	70	nC
⊋ _{gs}	Gate-Source Charge	V _{GS} = -4.5 V			8		nC
⊋ ^{gd}	Gate-Drain Charge				11		nC
DRAIN-SOU	RCE DIODE CHARACTERISTICS AND MAXIMU	IM RATINGS					
	Maximum Continuous Drain-Source Diode For	ward Current				-2.1	Α
s	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -2.1 A$ (Note	2)		-0.7	-1.2	V

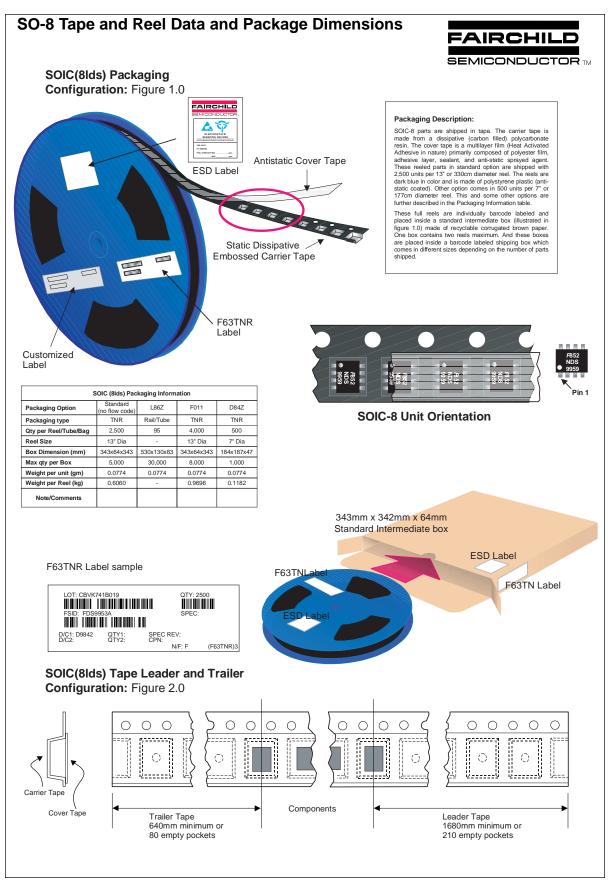
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

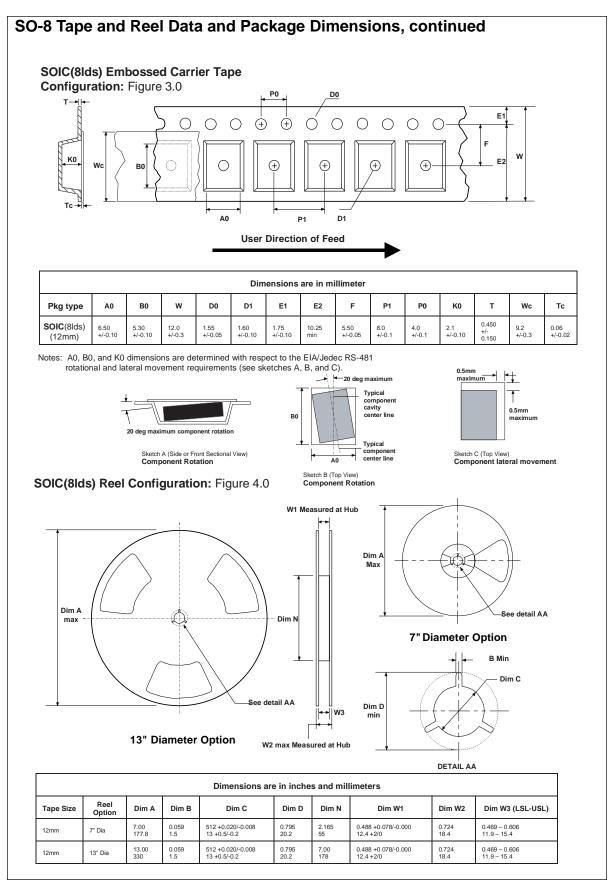


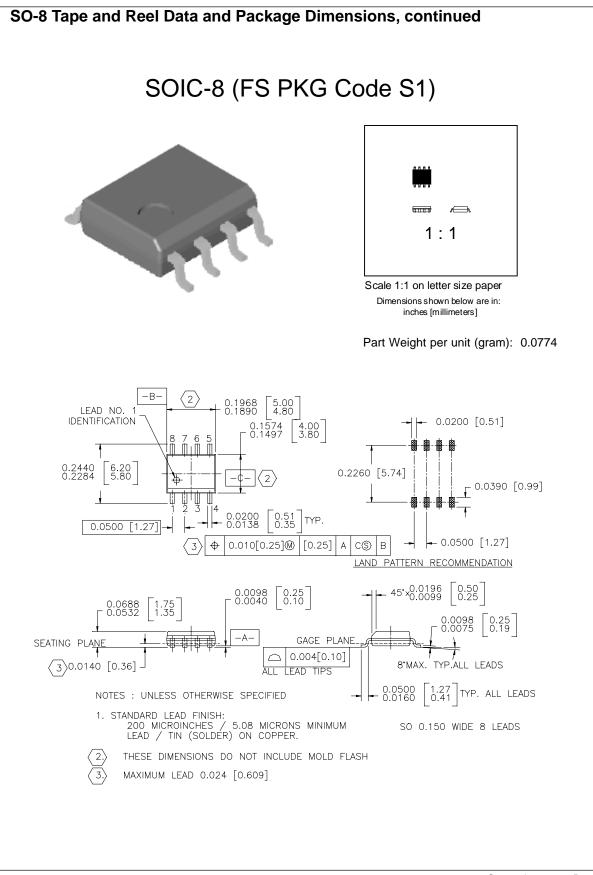
FDS6575 Rev.C1





July 1999, Rev. B





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